AS A BELOW NAMED INVENTOR, I hereby declare that:

My residence, post office address and citizenship are as stated next to my name.

I believe that I am the original, first and sole (if only one name is listed below), or an original, first and joint inventor (if plural names are listed below), of the subject matter which is claimed and for which a patent is sought on the invention entitled:

## TITLE: APPARATUS AND METHOD FOR CLEANING SEMICONDUCTOR SUBSTRATES

G was filed in the U.S. Patent & Trademark Office on and assigned Serial No.  G and (if applicable) was amended on	the specification of which either is at	ttached hereto or indicates an attorney dock	et no. 8836-242 (IH13145-US), or:
I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to patentability and to the examination of this application in accordance with Title 37 of the Code of Federal Regulations 1.56. I hereby claim foreign priority benefits under Title 35, U.S. Code 119(a)-(d) or 365(b) of any foreign application(s) for patent or inventor=s certificate, or 365(a) of any PCT international application which designated at least one country other than the United States, listed below and have also identified below any foreign applications for patent or inventor=certificate having a filing date before that of the application on which priority is claimed:    Priority Claimed: 2003-57249   KOREA   19 August 2003   (Day/Month/Year filed)	G was filed in the U.S. Patent &	Trademark Office on	and assigned Serial No
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Country   Country   August 2003   (Application Number)   (Country)   (Day/Month/Year filed)	claims, as amended by any amendment patentability and to the examination. I hereby claim foreign priority benefit or inventor=s certificate, or than the United States, listed below	ent referred to above. I acknowledge the du of this application in accordance with Title efits under Title 35, U.S. Code '119(a)-(d 365(a) of any PCT international application ow and have also identified below any for	aty to disclose information which is material to 237 of the Code of Federal Regulations '1.56 (1) or '365(b) of any foreign application(s) for which designated at least one country other foreign applications for patent or inventor
(Application Number)  (Country)  (Day/Month/Year filed)  (Application Number)  (Country)  (Day/Month/Year filed)  I hereby claim the benefit under Title 35, U.S. Code, '120 of any United States application(s), or '119(e) of any United States provisional application(s), or '365(c) of any PCT International application designating the United States, listed	Priority Claimed:		
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- DEIOW AND, HISOTAL AS THE SUDJECT MALLEL OF EACH OF THE CIAIMS OF THIS ADDICATION IS NOT DISCUSSED IN THE DITOL OTHICO STATES (	United States provisional application	n(s), or '365(c) of any PCT International a	pplication designating the United States, listed

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(Application Serial Number) (Filing Date) (STATUS: patented, pending, abandoned)

I hereby appoint the following attorneys: FRANK CHAU, Reg. No. 34,136; FRANK V. DeROSA, Reg. No. 43,584; NATHANIEL T. WALLACE, Reg. No. 48,909; ERIC M. PARHAM, Reg. No. 45,747; THOMAS W. McNALLY, Reg. No. 48,609; MICHAEL F. MORANO, Reg. No. 44,952; KOON H. WONG, Reg. No. 48,459; BENJAMIN M. HALPERN, Reg. No. 46,494; and RICHARD D. RATCHFORD JR., Reg. No. 53,865, and each of them of F. CHAU & ASSOCIATES, LLC, 1900 Hempstead Turnpike, Suite 501, East Meadow, New York 11554 to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith and with any divisional, continuation, continuation-in-part, reissue or re-examination application, with full power of appointment and with full power to substitute an associate attorney or agent, and to receive all patents which may issue thereon, and request that all correspondence be addressed to:

Frank Chau, Esq. F. CHAU & ASSOCIATES, LLC

Page 1 of 2

I HEREBY DECLARE that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under '1001 of Title 18 U.S. Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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